SONY

[Product Information] IMX327LQR/LQR1

Ver.1.3

Diagonal 6.46 mm (Type 1/2.8) CMOS Solid-state Image Sensor with Square Pixel for **Color Cameras**

Description

The IMX327LQR/LQR1 are diagonal 6.46 mm (Type 1/2.8) CMOS active pixel type solid-state image sensors with a square pixel array and 2.13 M effective pixels. These chips operate with analog 2.9 V, digital 1.2 V, and interface 1.8 V triple power supply, and have low power consumption. High sensitivity, low dark current and no smear are achieved through the adoption of R, G and B primary color mosaic filters. These chips feature an electronic shutter with variable charge-integration time.

(Applications: Surveillance cameras, FA cameras, Industrial cameras)

Features

- CMOS active pixel type dots
- Built-in timing adjustment circuit, H/V driver and serial communication circuit
- Input frequency: 74.25 MHz / 37.125 MHz
- ◆ Number of recommended recording pixels: 1920 (H) × 1080 (V) approx. 2.07 M pixel
- Readout mode All-pixel scan mode 720p-HD readout mode Window cropping mode Vertical / Horizontal direction-normal / inverted readout mode
- Readout rate Maximum frame rate in Full HD 1080p mode: 60 frame / s
- High dynamic range (HDR) function

Multiple exposure HDR

Digital overlap HDR

- Variable-speed shutter function (resolution 1H units)
- 10-bit / 12-bit A/D converter
- CDS / PGA function 0 dB to 29.4 dB: Analog Gain 29.4 dB (step pitch 0.3 dB) 29.7 dB to 71.4 dB: Analog Gain 29.4 dB + Digital Gain 0.3 to 42 dB (step pitch 0.3 dB)
- Supports I/O switching Low voltage LVDS (150 m Vp-p) serial (2 ch / 4 ch switching) DDR output CSI-2 serial data output (2 Lane / 4 Lane, RAW10 / RAW12 output)
- ♦ Recommended exit pupil distance: -30 mm to -∞
- Anti-reflective coating glass (IMX327LQR1), Non anti-reflective coating glass (IMX327LQR)

STARVIS

STARVIS is a trademark of Sony Corporation. The STARVIS is back-illuminated pixel technology used in CMOS image sensors for surveillance camera applications. It features a sensitivity of 2000 mV or more per 1 µm² (color product, when imaging with a 706 cd/m² light source, F5.6 in 1 s accumulation equivalent), and realizes high picture quality in the visible-light and near infrared light regions.

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Device Structure

- CMOS image sensor
- ♦ Image size
- Total number of pixels
- Number of effective pixels
- Number of active pixels
- Number of recommended recording pixels
- Unit cell size
- Optical black
- ♦ Dummy
- ♦ Package

Type 1/2.8 1945 (H) × 1109 (V) approx. 2.16 M pixels 1945 (H) × 1097 (V) approx. 2.13 M pixels 1937 (H) × 1097 (V) approx. 2.12 M pixels 1920 (H) × 1080 (V) approx. 2.07 M pixels 2.9 μ m (H) × 2.9 μ m (V) Horizontal (H) direction: Front 0 pixel, rear 0 pixel Vertical (V) direction: Front 10 pixels, rear 0 pixel Horizontal (H) direction: Front 0 pixel, rear 3 pixels Vertical (V) direction: Front 0 pixel, rear 0 pixel 110 pin LGA

Image Sensor Characteristics

(Tj = 60 °C)

Item		Value	Remarks	
Sensitivity (F5.6)	Тур.	10741 Digit (IMX327LQR) 11390 Digit (IMX327LQR1)	1/30s accumulation 12 bit converted value	
Saturation signal	Min.	3855 Digit	12 bit converted value	

Basic Drive Mode

Drive mode	Recommended number of recording pixels	Maximum frame rate [frame/s]	Output interface	ADC [bit]
Full HD 1080p	1920 (H) × 1080 (V) approx. 2.07M pixels	60	LVDS CSI-2	10/12
HD 720p	1280 (H) × 720 (V) approx. 0.92M pixels	60	LVDS CSI-2	10/12